

< GaN HEMT for satellite communication (SATCOM) earth station>

MGFK48G2732A

Ku band internally matched power GaN HEMT 12.75 - 13.25 GHz BAND / 70W Multi-carrier operable

DESCRIPTION

The MGFK48G2732A, GaN HEMT with an N-channel schottky gate, is designed for Ku-band applications with multi-carrier operation.

: VDS=24V

FEATURES

- High voltage operation
- High output power
- High efficiency

: Po=48.3dBm (TYP.) @Pin=42dBm

- : PAE=31% (TYP.) @́Pin=42dBm
- Wide offset frequency : Up to 400MHz
- Designed for use in Class AB linear amplifiers

APPLICATION

Amplifier for Ku-band SATCOM

QUALITY

General & Industrial

Packaging

• Individual case

RECOMMENDED BIAS CONDITIONS

• Vds=24V • Ids=1.44A • Rg=13.3Ω

Absolute maximum ratings (Ta=25°C)

Symbol	Parameter	Ratings	Unit
Vgso	Gate - Source Voltage	-10	V
Vds	Drain - Source Voltage	27	V
IGF	Forward Gate Current	100	mA
IGR	Reverse Gate Current	-24	mA
τ	Screw Torque	49	N∙cm
PT*1	Total Power Dissipation	225	W
Pin	Input Power	≦44	dBm
Tch	Channel Temperature	250	°C
Tstg	Storage Temperature	-55 to +125	°C
Тс	Case Operating Temperature	100	°C

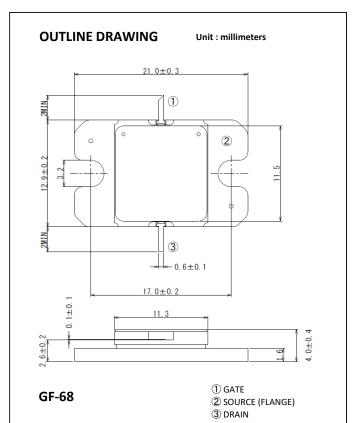
*1:Tc=25°C

Recommended operating Condition

Symbol	Parameter	Limit	Unit
Тс	Case Operating Temperature	85	°C
Vds	Drain - Source Voltage	24	V
IDQ	Drain Quiescent Current	1.44	А
Rg	Gate Resistance	13.3	Ω

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Electrical characteristics (Ta=25°C)

Parameter	Symbol	Test conditions		Limits		Unit
			Min.	Тур.	Max.	
Pinch-off Voltage	VGS(off)	Vds=24V,ID=28.8mA	-1	-	-5	V
Output Power	Pout *2	Vds=24V,IDQ=1.44A f=12.75 ,13.00, 13.25GHz -*2 : Pin=42dBm *3 : Pin=27dBm	47.3	48.3	-	dBm
Power Added Efficiency	PAE *2		-	31	-	%
Linear Power Gain	GLP *3		9	11	-	dB
3 rd Order Intermodulation	IM3	Two-tone Test,Po=39.3dBm (Single Carrier Level) Δ f=5MHz(IM3), Δ f=200MHz(IM3-2),	-25	-	-	dBc
distortion	IM3-2		-24	-	-	
	IM3-3	Δ f=400MHz(IM3-3)	-24	-	-	
Thermal Resistance	Rth(ch-c) *4	Δ Vf method	-	0.8	1.0	°C/W

*4 :Channel-case

Specifications are subject to change without notice

ESD *5	Class 0	-199~	
*5 :Based on EIAJ ED-4701 C-111A(C=100pF,R=1.5kΩ)			

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